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(12) **United States Design Patent** (10) **Patent No.:** **US D968,957 S**
Heinle et al. (45) **Date of Patent:** **** Nov. 8, 2022**

(54) **TRAY FOR TRANSPORTING AND STORING ELECTRONIC COMPONENTS**

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(**) Term: **15 Years**

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(51) **LOC (13) Cl.** **09-07**

(52) **U.S. Cl.**
USPC **D9/456**

(58) **Field of Classification Search**
USPC D9/456, 499, 427, 730, 732, 736, 737, D9/748, 749, 755, 759, 760, 761, D9/433-436; D7/311, 396.1, 396.4, D7/550.1, 553.2, 553.3, 554.3, 555, 601, D7/602, 620, 704; D23/260, 261; D5/1-3, 46, 47, 54; D3/201, 272, 304
CPC H01L 23/552
See application file for complete search history.

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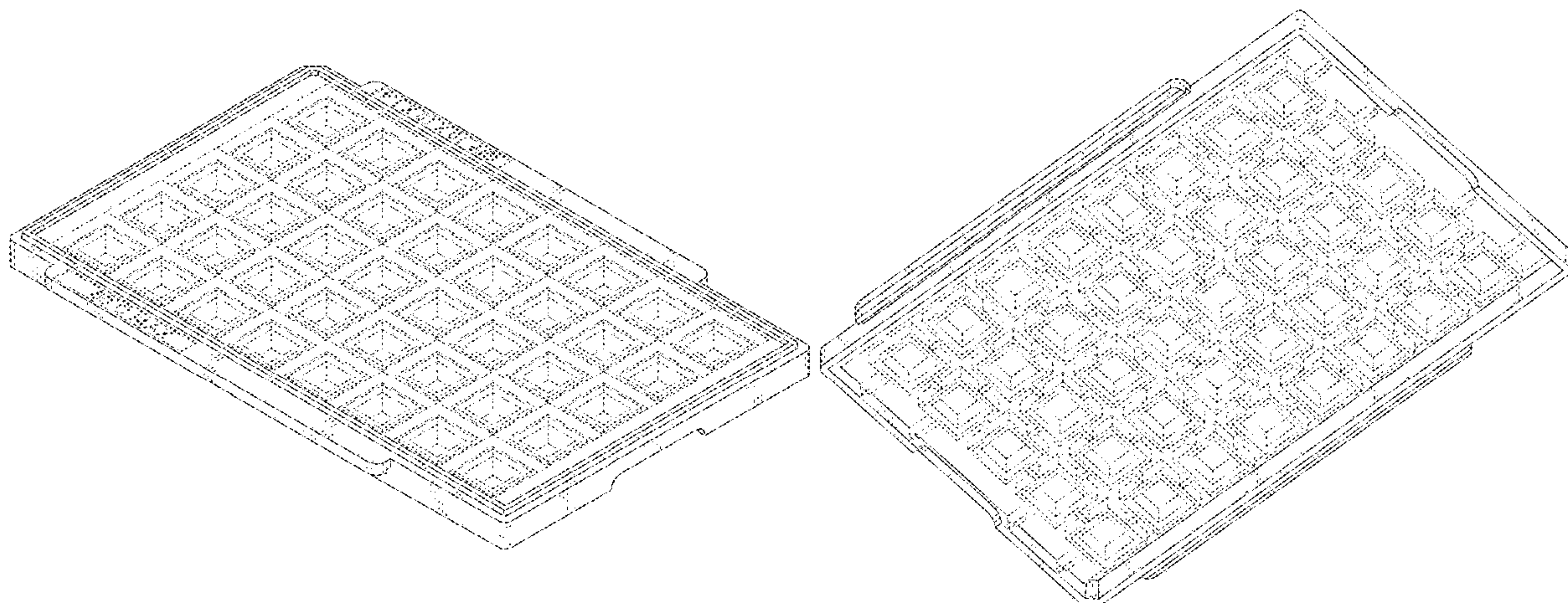
(57) **CLAIM**

The ornamental design for a tray for transporting and storing electronic components, as shown and described.

DESCRIPTION

FIG. 1 is a top perspective view of the tray for transporting and storing electronic components;
FIG. 2 is a bottom perspective view of the tray for transporting and storing electronic components of FIG. 1;
FIG. 3 is a top plan view of the tray for transporting and storing electronic components of FIG. 1;
FIG. 4 is a bottom plan view of the tray for transporting and storing electronic components of FIG. 1;
FIG. 5 is a left side elevational view of the tray for transporting and storing electronic components of FIG. 1;
FIG. 6 is a right side elevational view of the tray for transporting and storing electronic components of FIG. 1;
FIG. 7 is a front elevational view of the tray for transporting and storing electronic components of FIG. 1;
FIG. 8 is a rear elevational view of the tray for transporting and storing electronic components of FIG. 1;
FIG. 9 is a cross-sectional view taken through the line 9-9 in FIG. 3; and,
FIG. 10 is a cross-sectional view taken through the line 10-10 in FIG. 3.
The broken lines in the drawings illustrate portions of the tray for transporting and storing electronic components that form no part of the claimed design.

1 Claim, 10 Drawing Sheets



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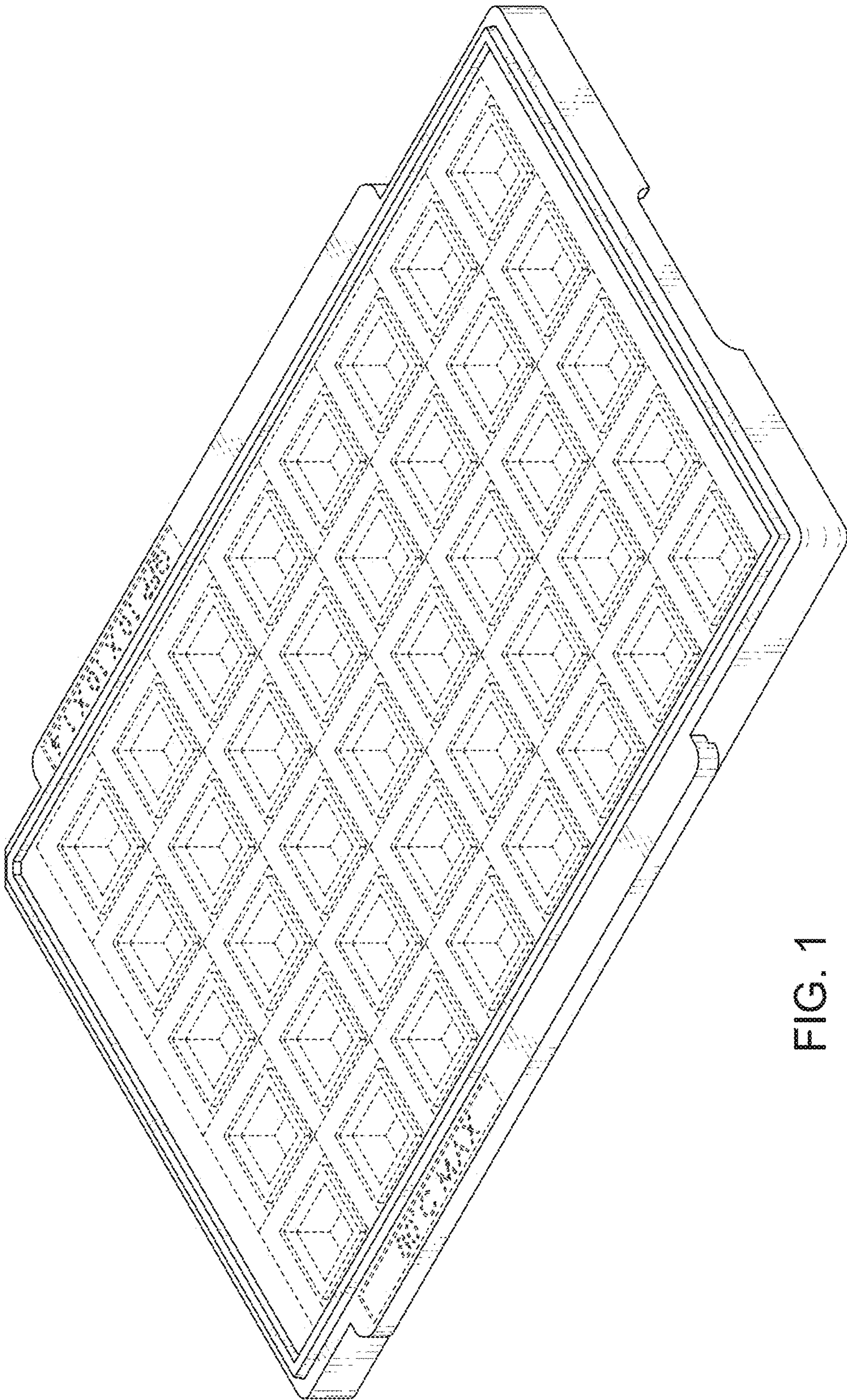


FIG. 1

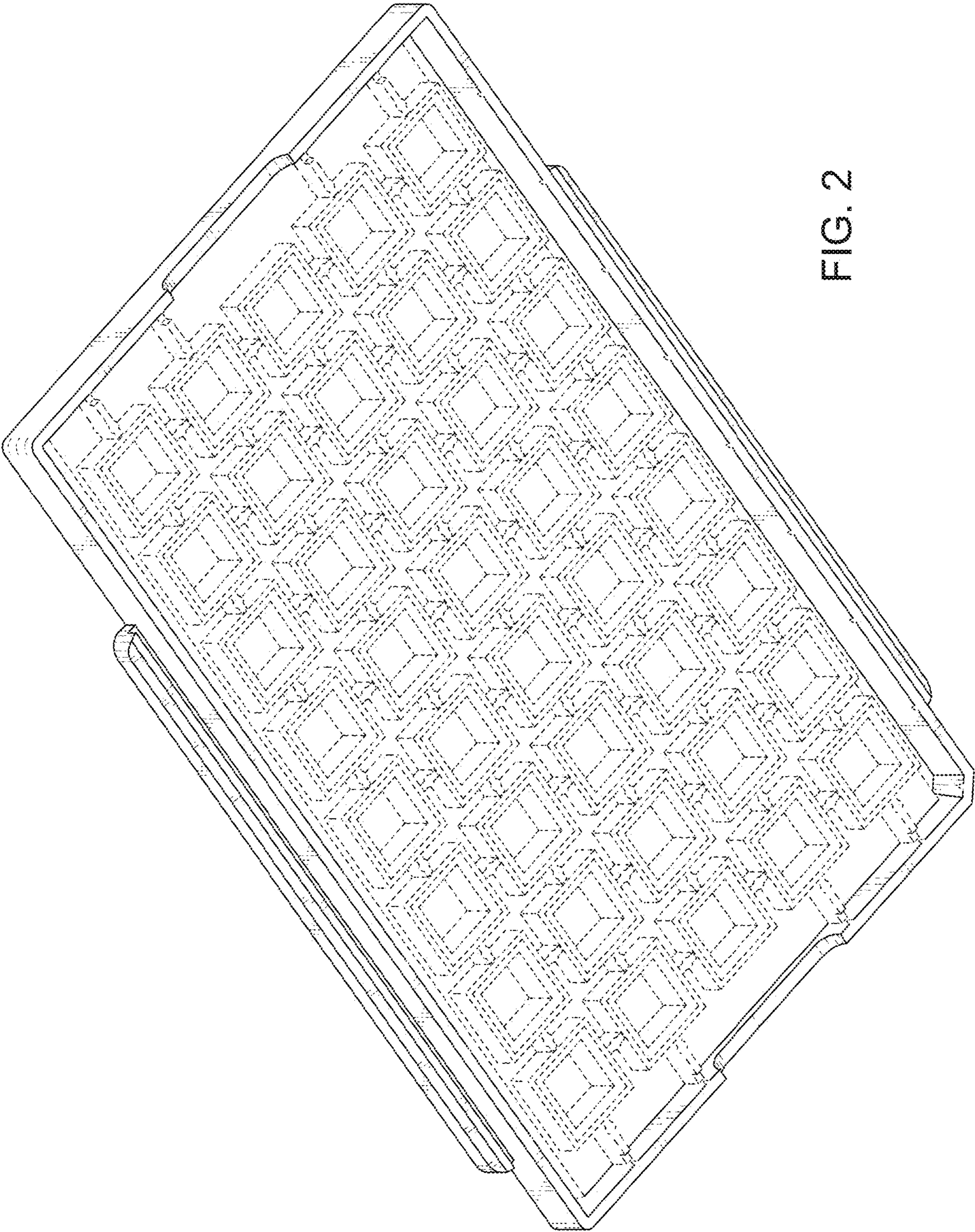


FIG. 2

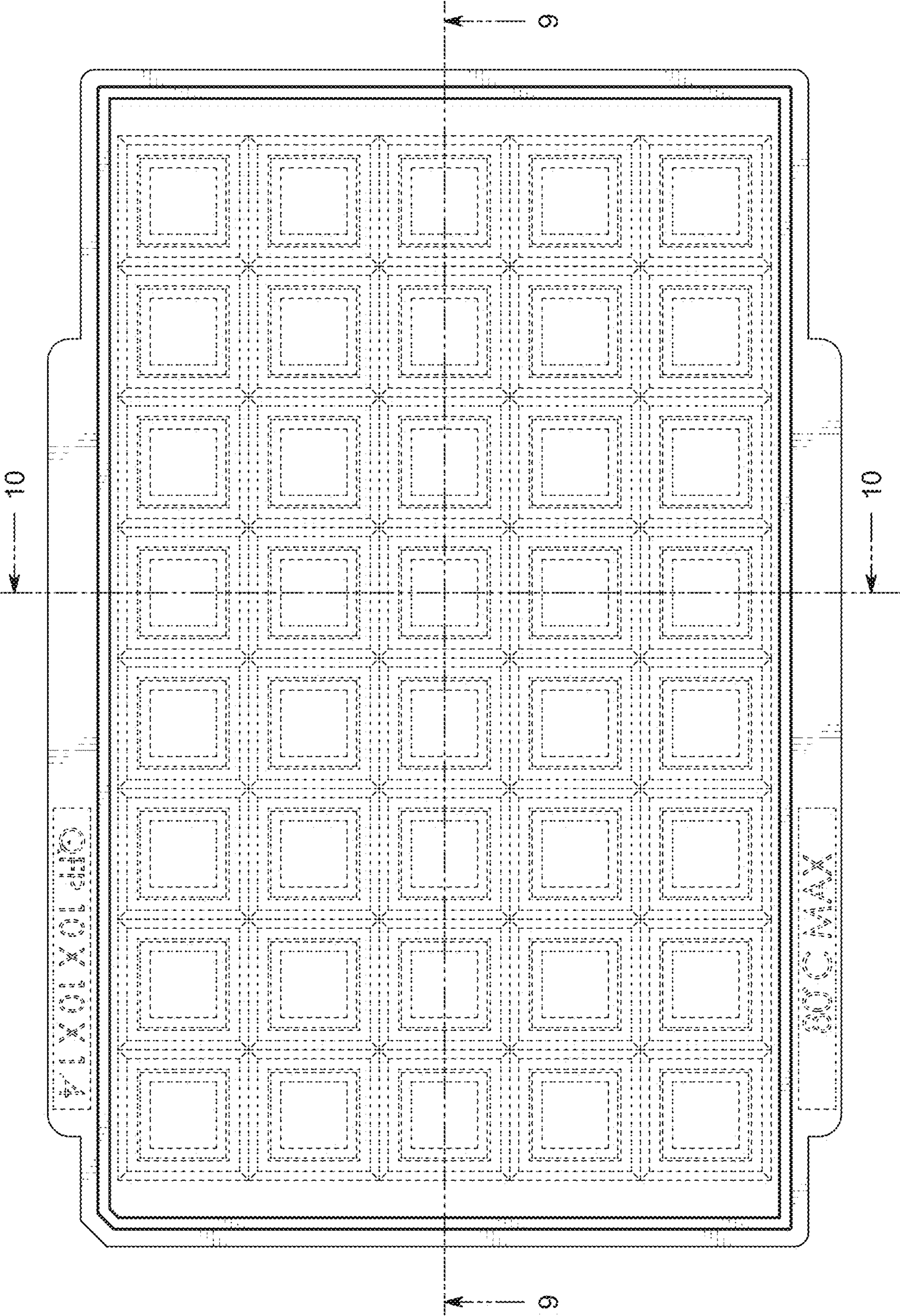


FIG. 3

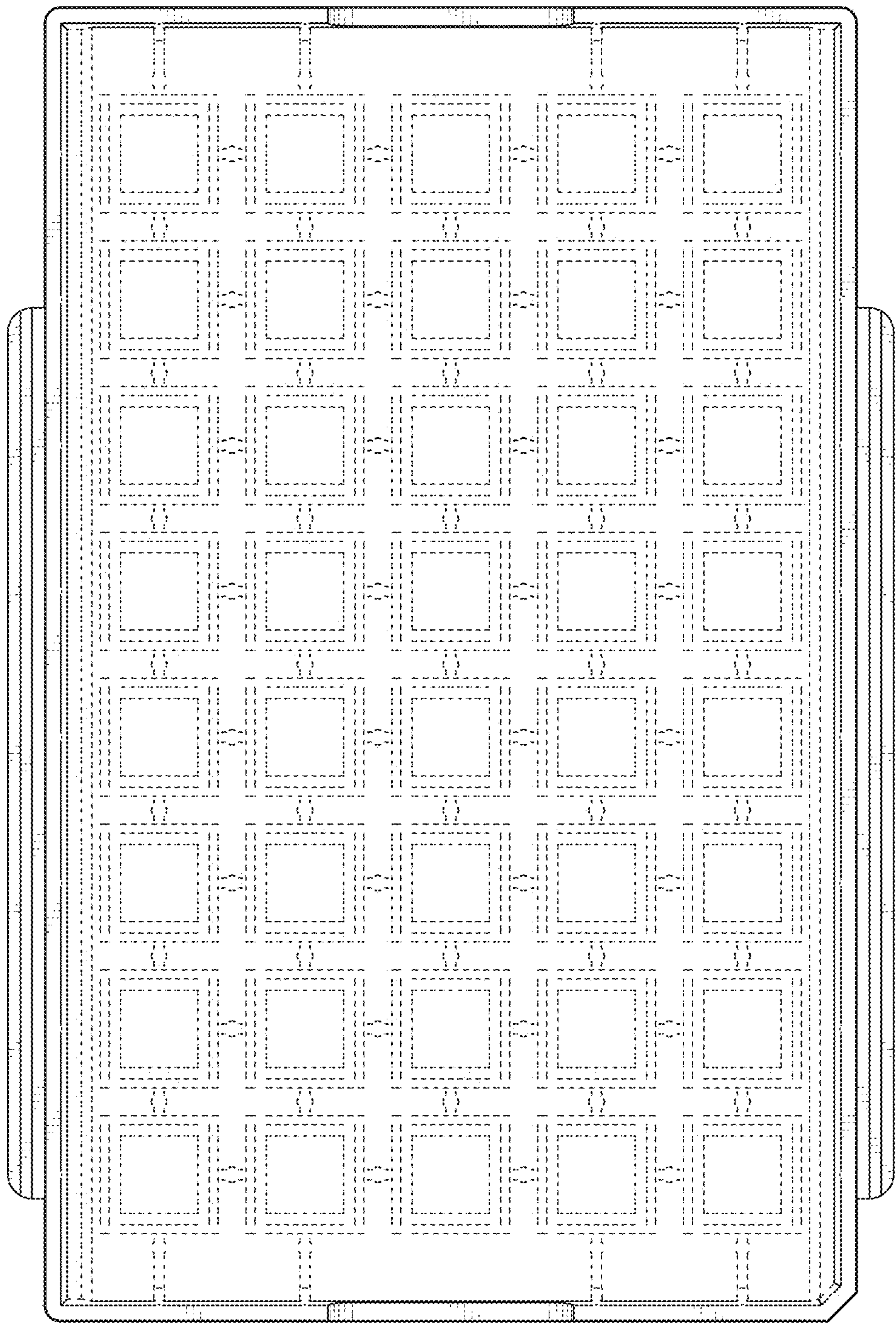


FIG. 4



FIG. 5

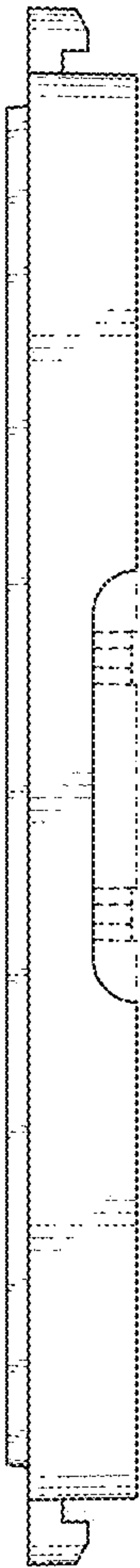


FIG. 6



FIG. 7

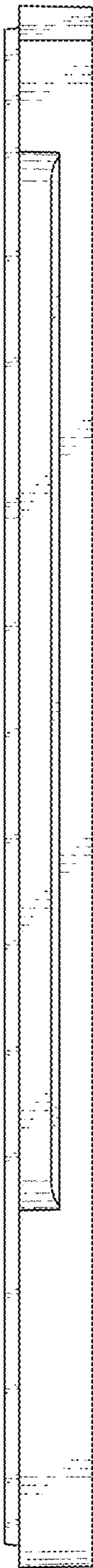


FIG. 8

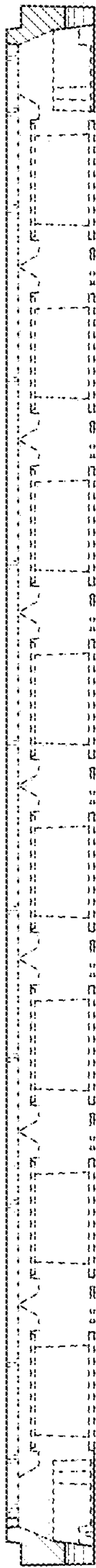


FIG. 9

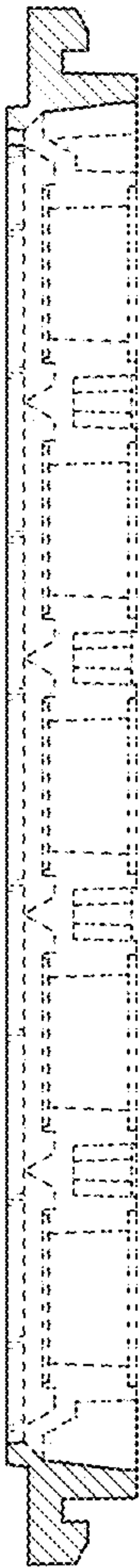


FIG. 10